

- 1. ALL RESISTANCE VALUES ARE IN OHMS, 0.1 WATT +/- 5%.
- 2. ALL CAPACITANCE VALUES ARE IN MICROFARADS.
- 3. ALL CRYSTALS & OSCILLATOR VALUES ARE IN HERTZ.

REV	ZONE	ECN	DESCRIPTION OF CHANGE	CK APPD DATE	ENG APPD DATE
03		437070	ENGINEERING RELEASED	04/27/06	?

M51 HEATSINK AND AMBIENT TEMP SENSOR BOARDS

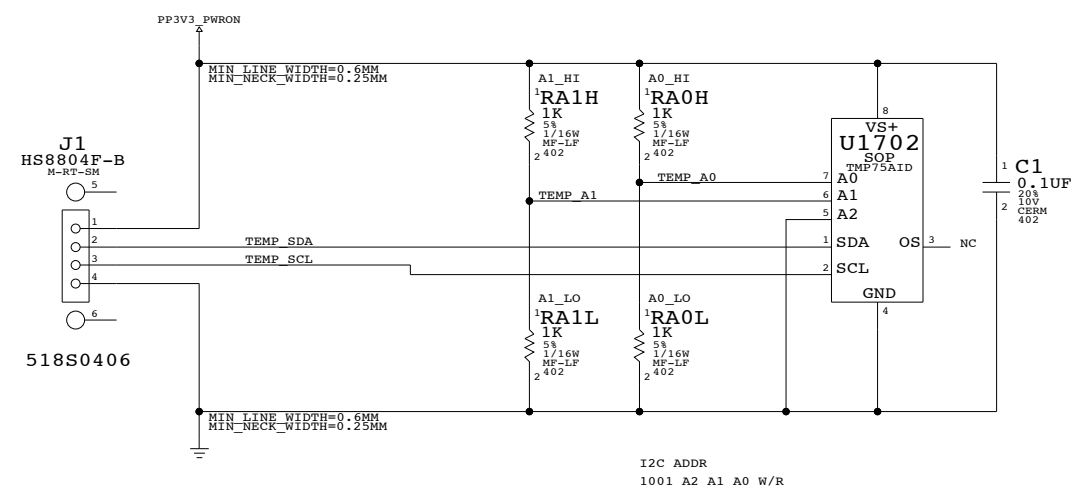
04/27/06

BOM NUMBER	BOM NAME	BOM OPTIONS
630-7602	HEATSINK_TEMP,M51	COMMON,ALTERNATE,HSK,ADDR_94
630-7603	AMBIENT_TEMP,M51	COMMON,AMB,ADDR_96

BOM GROUP	BOM OPTIONS
ADDR_90	A1_LO,A0_LO
ADDR_92	A1_LO,A0_HI
ADDR_94	A1_HI,A0_LO
ADDR_96	A1_HI,A0_HI

PART#	QTY	DESCRIPTION	REFERENCE DESIGNATOR(S)	CRITICAL	BOM OPTION
051-7127	1	SCH,HSK_AMB_TSENSE,M51	SCH1		
820-2035	1	PCB,HSK TEMP SENSOR,M51	PCB1		HSK
820-2036	1	PCB,AMB TEMP SENSOR,M51	PCB1		AMB
946-0709	1	THERMAL TAPE, M51	ADH1		HSK
946-0713	1	ADHESIVE, M51 AMB TEMP	ADH1		AMB

PART NUMBER	ALTERNATE FOR PART NUMBER	BOM OPTION	REF DES	COMMENTS:
820-2058	820-2035		ALL	2-LAYER VERSION



DIMENSIONS ARE IN MILLIMETERS		METRIC		Apple Computer Inc.	
XX : _____	_____	DRAPTR	DESIGN CK	NOTICE OF PROPRIETARY PROPERTY THE INFORMATION CONTAINED HEREIN IS THE PROPRIETARY PROPERTY OF APPLE COMPUTER, INC. THE POSSESSOR AGREES TO THE FOLLOWING: I TO MAINTAIN THE DOCUMENT IN CONFIDENCE II NOT TO REPRODUCE OR COPY IT III NOT TO REVEAL OR PUBLISH IN WHOLE OR PART	
X.XX : _____	_____	ENG APPD	MFG APPD		
X.XXX : _____	_____	QA APPD	DESIGNER		
ANGLES : _____	_____	RELEASE	SCALE		
DO NOT SCALE DRAWING		NONE		TITLE	
 THIRD ANGLE PROJECTION		MATERIAL/FINISH NOTED AS APPLICABLE		SIZE D DRAWING NUMBER 051-7127 REV. 03	
		SHT 1 OF 1			